

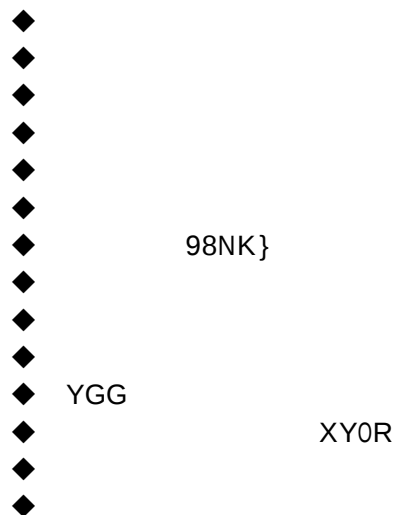
Rev.A Apr.-2019

EUDG9888DP I

VRW5609

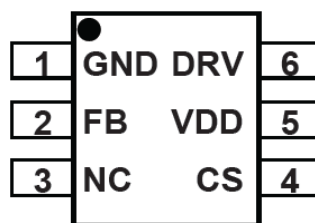
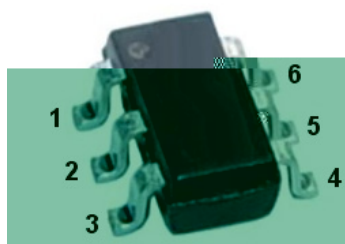
S Z P

DF0GF



DF0GF

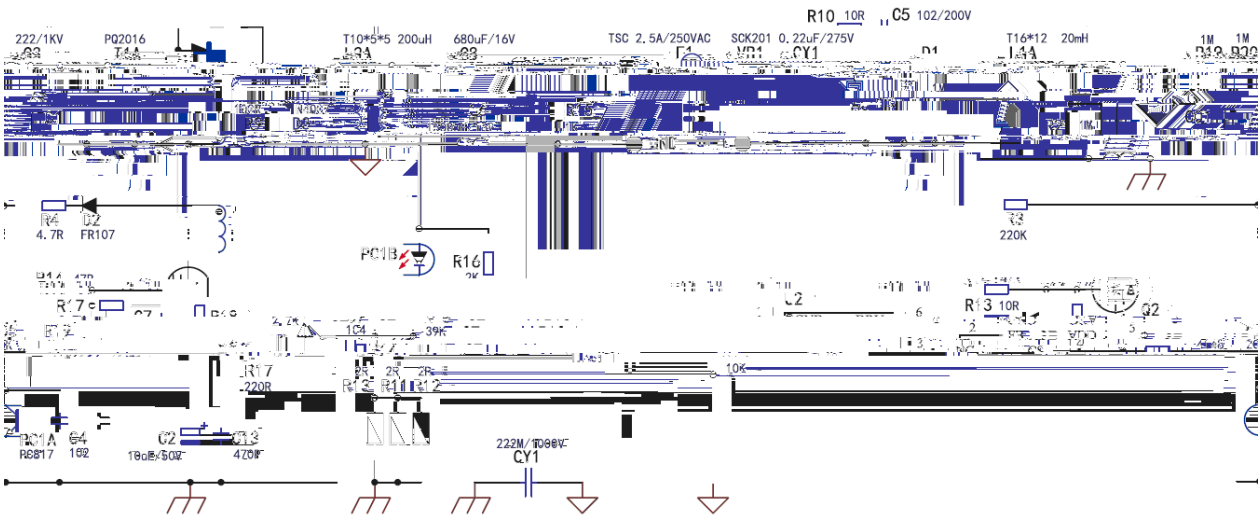
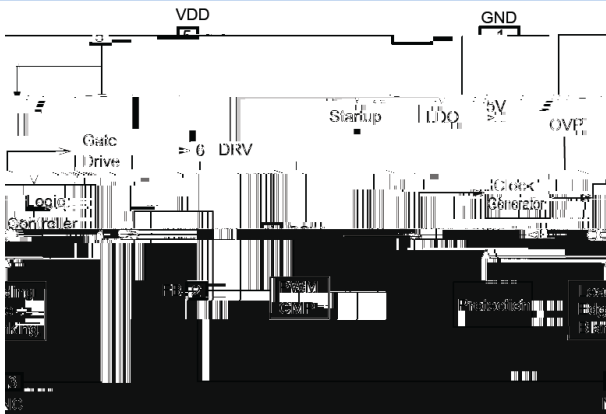
SF



Siq Qx p euu

Siq Qd p e

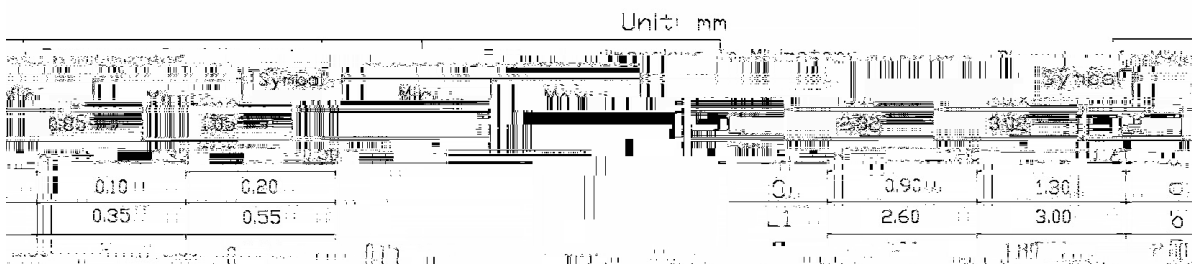
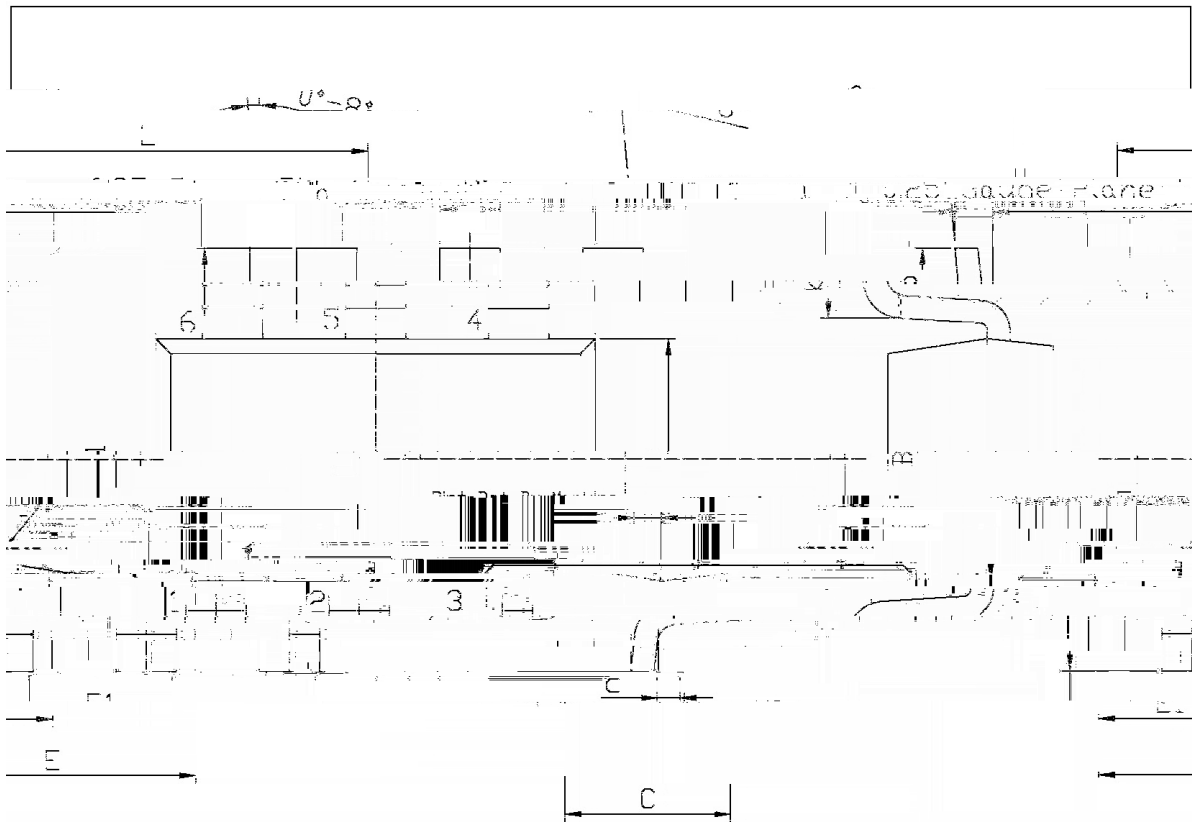
Siq Gevfuiswi r q



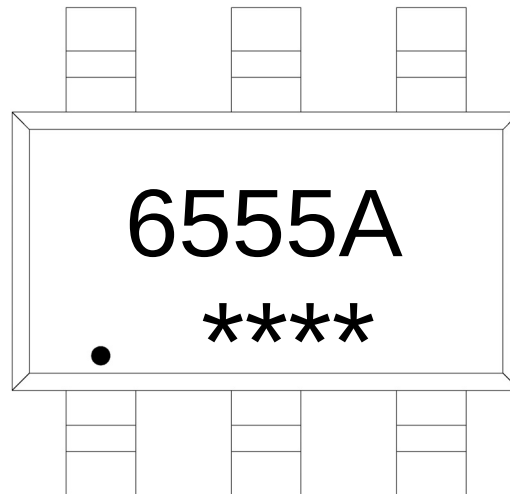
/Parameter	/Value	/Unit
VDD	-0.3-28	V
FB	-0.3-6	V
DRV	-0.3-15	V
CS	-0.3-6	V
	-40-125	
	-65-150	

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
I_ST		VDD_ON-1V		3	20	uA
VTH_ON		VDD	15.5	16.5	VDD	V
VTH_OFF		VDD	7	8		

EUDG9888DP I	S Z P			
EUDG9888DP I				
YGG	YGG			
EUDG9888DP I				
98NK}			S I P	
EUDG9888DP I				
EUDG9888DP I	VRW5609			
		0eye09	Hxu5:3	
				YGG
YGG				
7 pv				
EUDG9888DP I				
HPL				
EUDG9888DP I	FF P		98NK}1	HPL
9%				
EUDG9888DP I		IE		
				IE
715Y	93 pv/			
EUDG9888DP I				
EUDG9888DP I				



SMT23-6



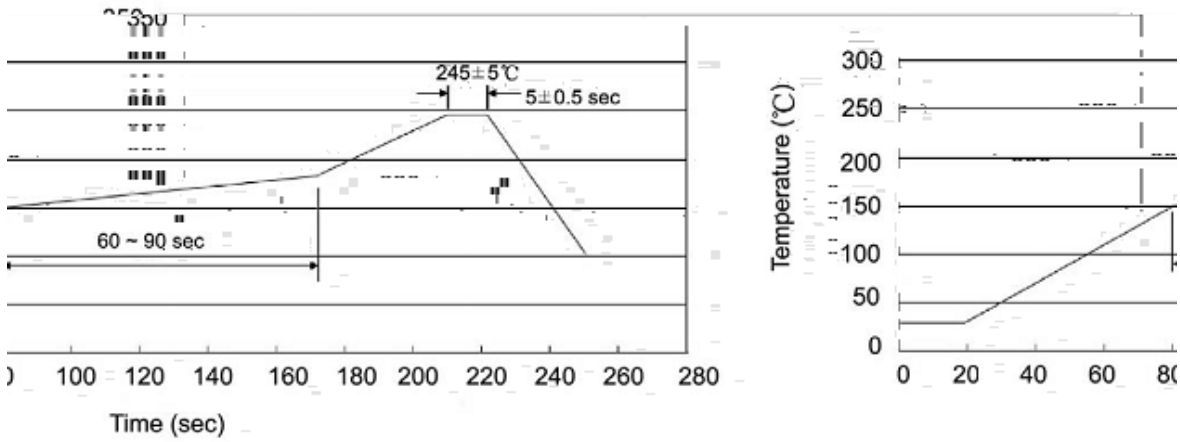
9888D

Note:

9888D: Product Type.

****: Lot No. Code, code change with Lot No.

Temperature Profile for IR Reflow Soldering(Pb-Free)



Note:

- 1

150 180

60 90sec;
- 2

245±5

5±0.5sec;
- 3

2 10 /sec.
- 1.Preheating:150~180

, Time:60~90sec.
- 2.Peak Temp.:245±5

, Duration:5±0.5sec.
3. Cooling Speed: 2~10

/sec.

±5

±1 sec.

Temp.:260±5

Time:10±1 sec

/ REEL

Sdfndge W se	Xqiw					Gipeqvirq			+xqiw p p ⁶ ,
	Xqiw2Uee0	Ueev2Lqqeu Er{	Xqiw2Lqqeu Er{	qqeu Er{ev2Rxweu Er	Xqiw2Rxweu Er{	Uee0	Lqqeu Er{	Rxweu Er{	
VRW560829	6/333	43	63/333	7	453/333	: × ;	543×538×538	778×563×768	